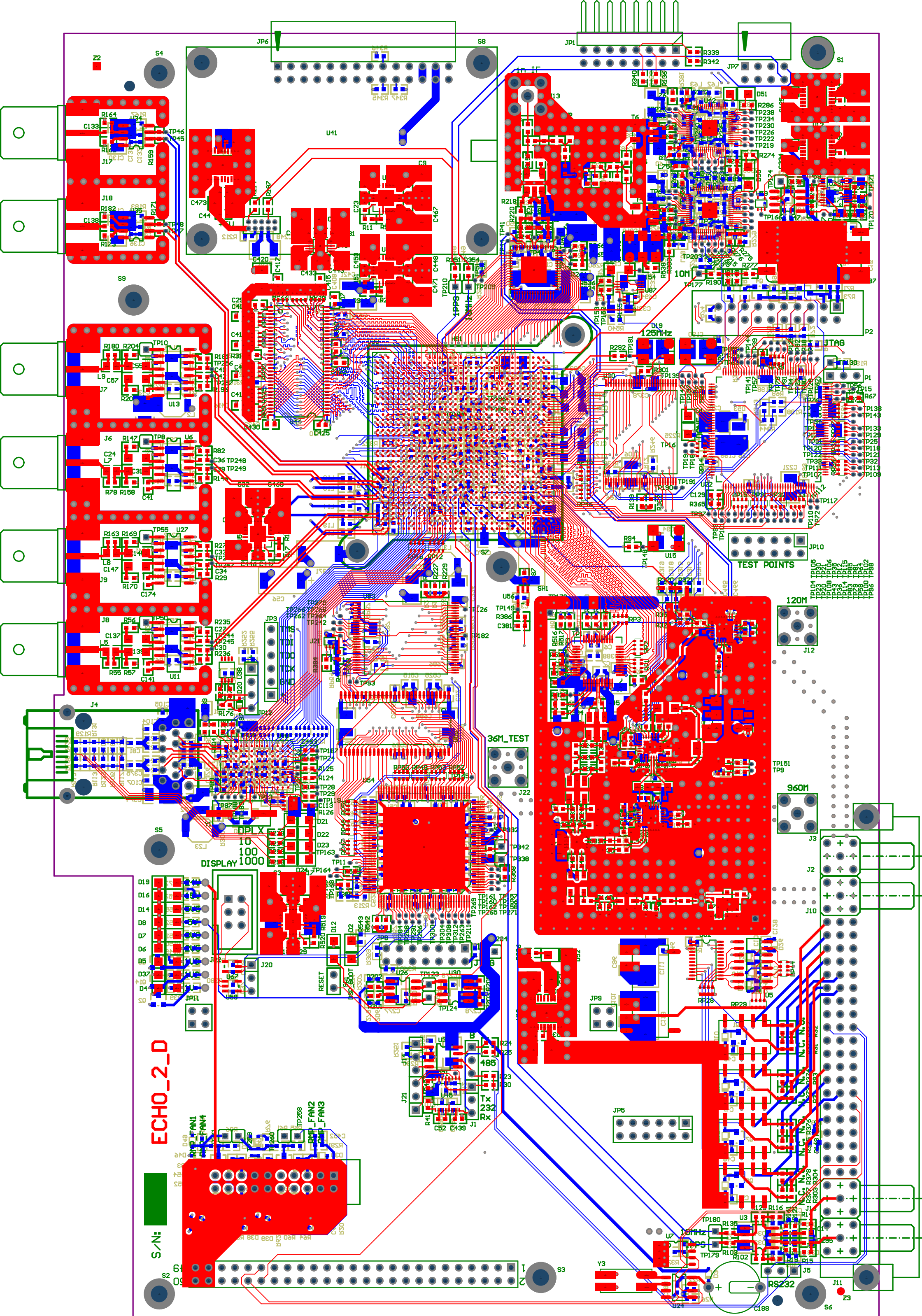


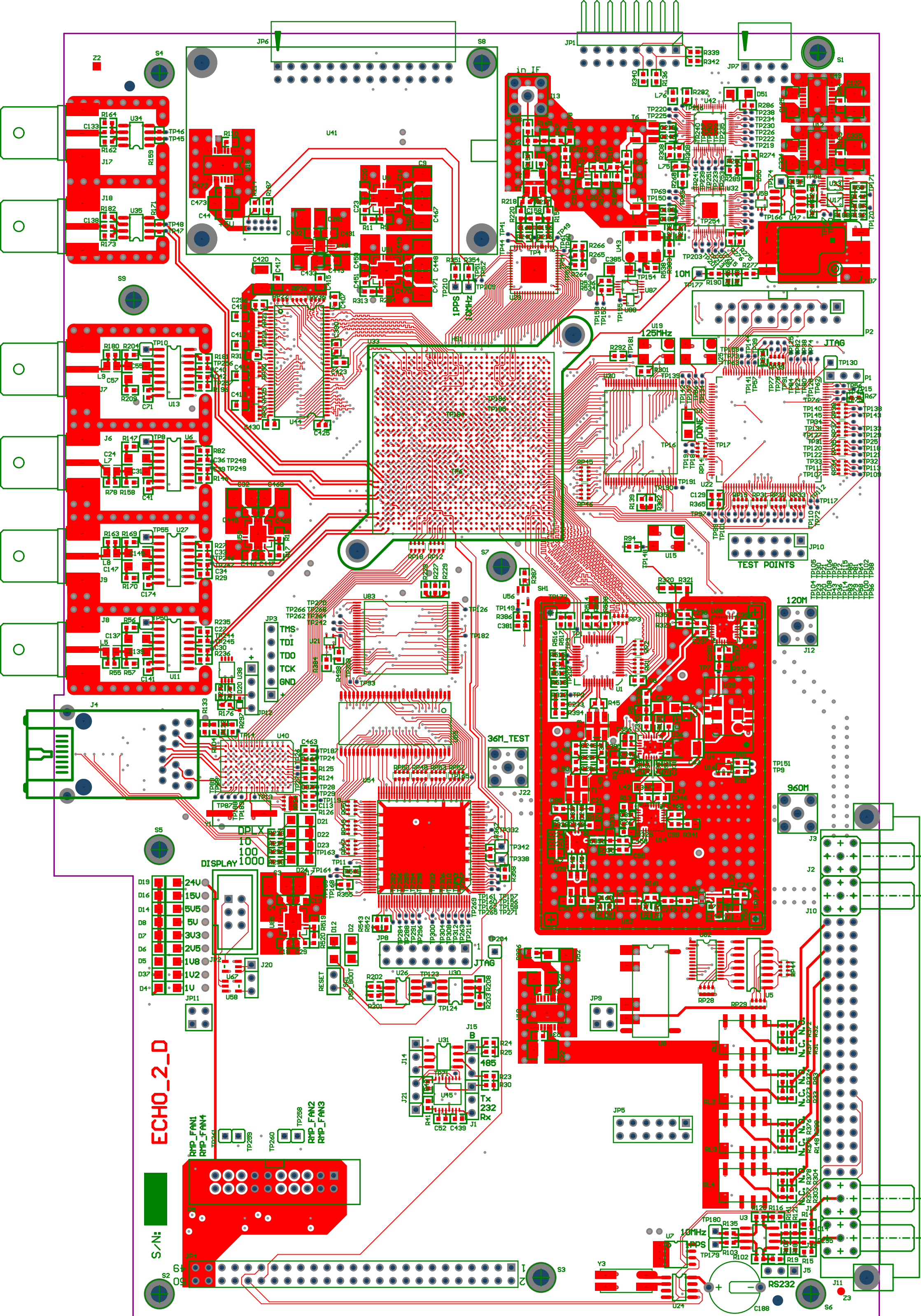


Top Layer
Top Overlay

Bottom Layer
Bottom Overlay

Keep-Out Layer

Layer Stack Up Detail for: Echo_2_D.PcbDoc			
Layer Name	Gerber Document	Copper Thickness	Dielectric Height
Top Solder Mask	(.GTS)		0.0102mm
Top Layer	(.GTL)	0.017mm	
InternalPlane1	(.GP1)	0.035mm	0.18mm
MidLayer	(.G1)	0.035mm	0.18mm
InternalPlane2	(.GP2)	0.035mm	0.22mm
InternalPlane3	(.GP3)	0.035mm	0.11mm
MidLayer2	(.G2)	0.035mm	0.22mm
InternalPlane4	(.GP4)	0.035mm	0.18mm
Bottom Layer	(.GBL)	0.017mm	
Bottom Solder Mask	(.GBS)		0.0102mm

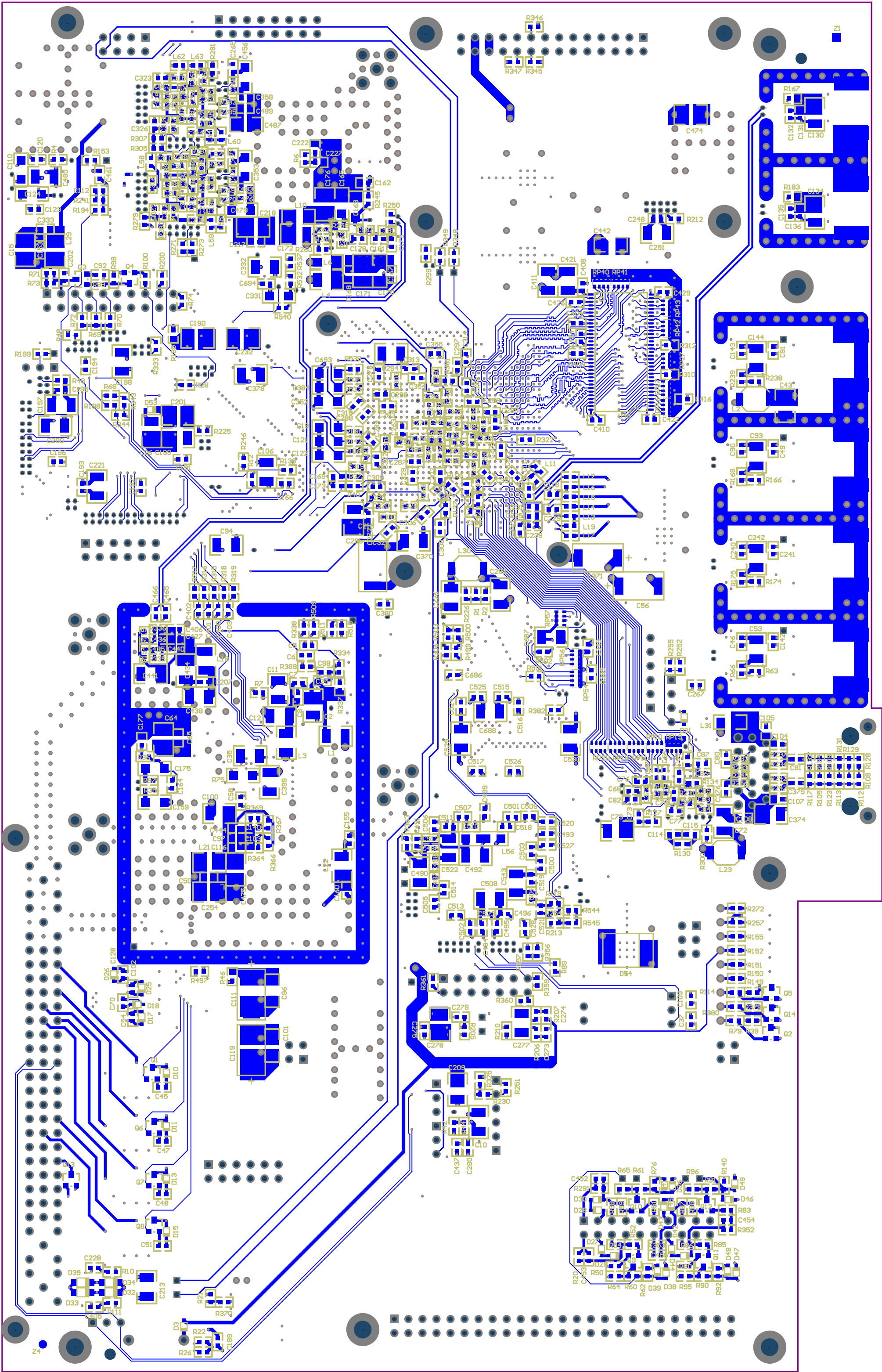


Top Layer
Top Overlay

Keep-Out Layer

Layer Stack Up Detail for: Echo_2_D.PcbDoc			
Layer Name	Gerber Document	Copper Thickness	Dielectric Height
Top Solder Mask	(.GTS)		0.0102mm
Top Layer	(.GTL)	0.017mm	
InternalPlane1	(.GP1)	0.035mm	0.18mm
MidLayer	(.G1)	0.035mm	0.18mm
InternalPlane2	(.GP2)	0.035mm	0.22mm
InternalPlane3	(.GP3)	0.035mm	0.11mm
MidLayer2	(.G2)	0.035mm	0.22mm
InternalPlane4	(.GP4)	0.035mm	0.18mm
Bottom Layer	(.GBL)	0.017mm	
Bottom Solder Mask	(.GBS)		0.0102mm

Layer Stack Up Detail for: Echo_2.D.PcbDoc			
Layer Name	Document Thickness	Copper Thickness	Dielectric Height
Bottom Solder Mask (.GB2)	0.015mm		
Bottom Layer	0.015mm		
Internal Plane4 (.GP4)	0.035mm		0.18mm
MiddleLayer2	0.035mm		0.18mm
Internal Plane3 (.GP3)	0.035mm		0.22mm
Internal Plane2 (.GP2)	0.035mm		0.22mm
MiddleLayer	0.035mm		0.18mm
Internal Plane1 (.GP1)	0.035mm		0.18mm
Top Layer	0.015mm		
Top Solder Mask (.GT2)	0.015mm		



Bottom Layer
Bottom Overlay